



HONGLI ZHIHUI
鸿利智汇

BYTECH

Technical Data Sheet

Specification

CMH335C2F21Z0



BYTECH

Bytech Electronics CO., Ltd is the first company in China to produce and sale the real inorganic UV LED devices which based on CMH package technology.

CMH package technology platform is a kind of package technology which adopts ceramic, metal, hard glass as package materials. CMH technology platform originates independent intellectual property owned by Bytech Electronics CO., LTD, which is suitable for vacuum encapsulation, especially suitable for ensuring reliability of deep UV products.

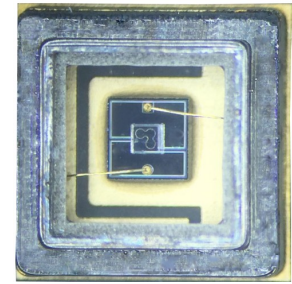
DESIGN	CHECKED	APPROVED
2018.08.14	2018.08.14	2018.08.14
XIONG	研发专用章	研发专用章



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Mass Production	●



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES



Features

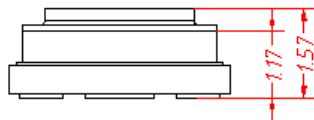
- CMH real inorganic package
- Dimension 3.70mm×3.70mm×1.67mm
- Long operating life
- Deep ultraviolet
- High reliability
- Superior ESD protection
- RoHS compliant

Applications

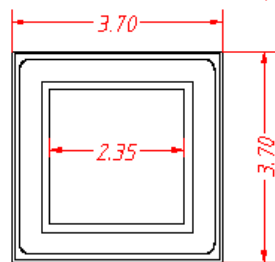
- Sterilization and disinfection
- Fluorescent spectroscopy
- Water purification
- Air purification

Package Dimensions (Unit: mm)

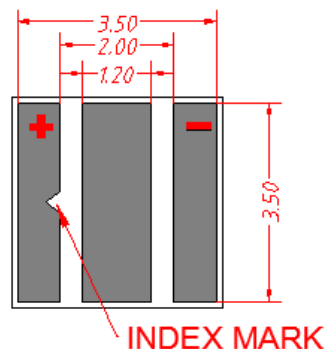
Side View



Top View



Bottom View



Product ID:

CMH335C2F21Z0

Where,

CMH: package technology

3: radiation angle, 120°

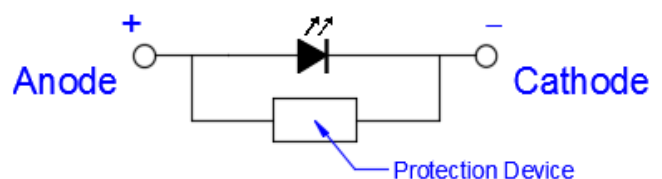
35: package size, 3.5mm*3.5mm

C2: peak wavelength, 275~285nm

F21: LED chip code, flip chip

Z0: Zener chip code

Circuit:



Tolerance : ± 0.20mm



Characteristics of UV LED

1. Electrical / Optical Characteristics (@IF=20mA, Ta=25°C, RH=40%)

Parameter	Symbol	Units	Value
Peak Wavelength [1]	λ_p	nm	275-285
Radiant Flux [2]	Φ_e [3]	mW	2-3
Forward Voltage [4]	VF	V	5-7
Thermal Resistance [5]	R_{th}	°C/W	—
Spectrum Half Width	$\Delta\lambda$	nm	10.5
View Angle	$2\theta_{1/2}$	deg	120

Notes:

- [1]. Peak wavelength measurement tolerance: $\pm 3\text{nm}$
[2]. Radiant flux measurement tolerance: $\pm 10\%$
[3]. Φ_e is the total radiant flux as measured with an integrated sphere
[4]. Forward voltage measurement tolerance: $\pm 3\%$
[5]. R_{th} is the thermal resistance between junction to substrate.

2. Absolute Maximum Ratings ($T_a=25^\circ\text{C}$, RH=40%)

Parameter	Symbol	Units	Value
Maximum Rating Forward Current	I_{Fmax}	mA	30
Maximum Rating Junction Temperature	T_{jmax}	°C	120
Operating Temperature Range	T_{opr}	°C	-40 ~ +60
Storage Temperature Range	T_{stg}	°C	-40 ~ +100

Notes:

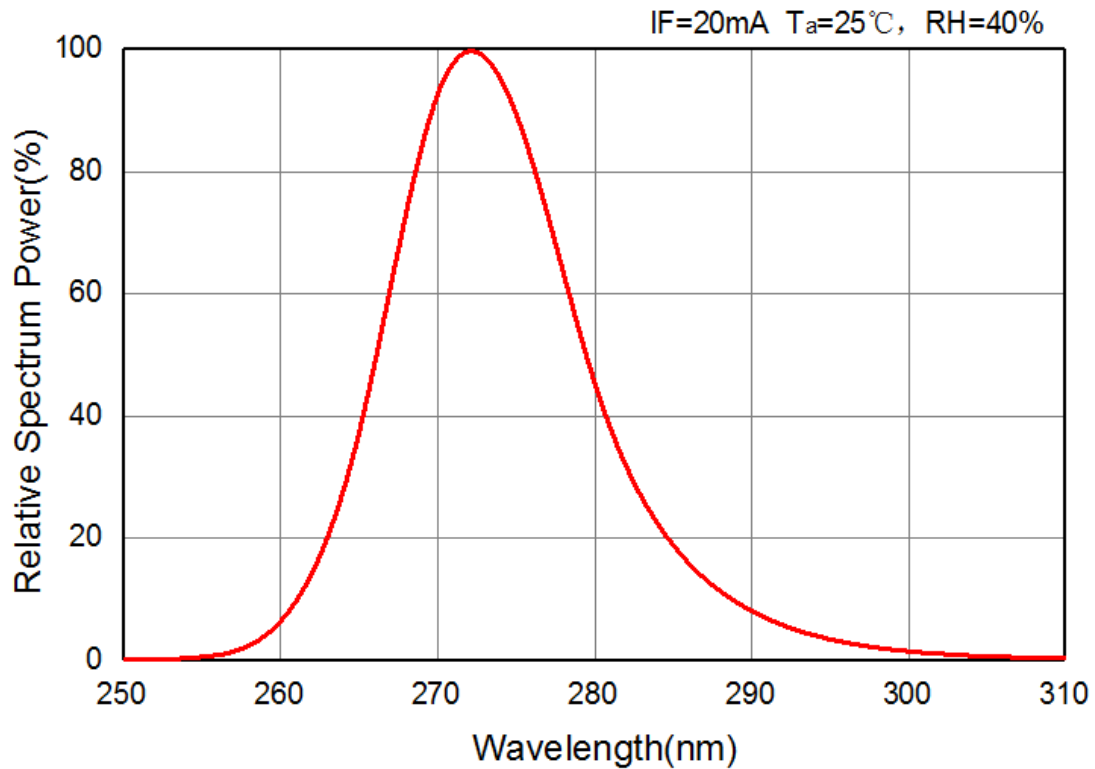
Operating the LED beyond the listed maximum ratings may affect device's reliability and cause permanent damage. These or any other conditions beyond those indicated under recommended operating conditions are not implied. The exposure to the absolute maximum rated conditions may affect device reliability.



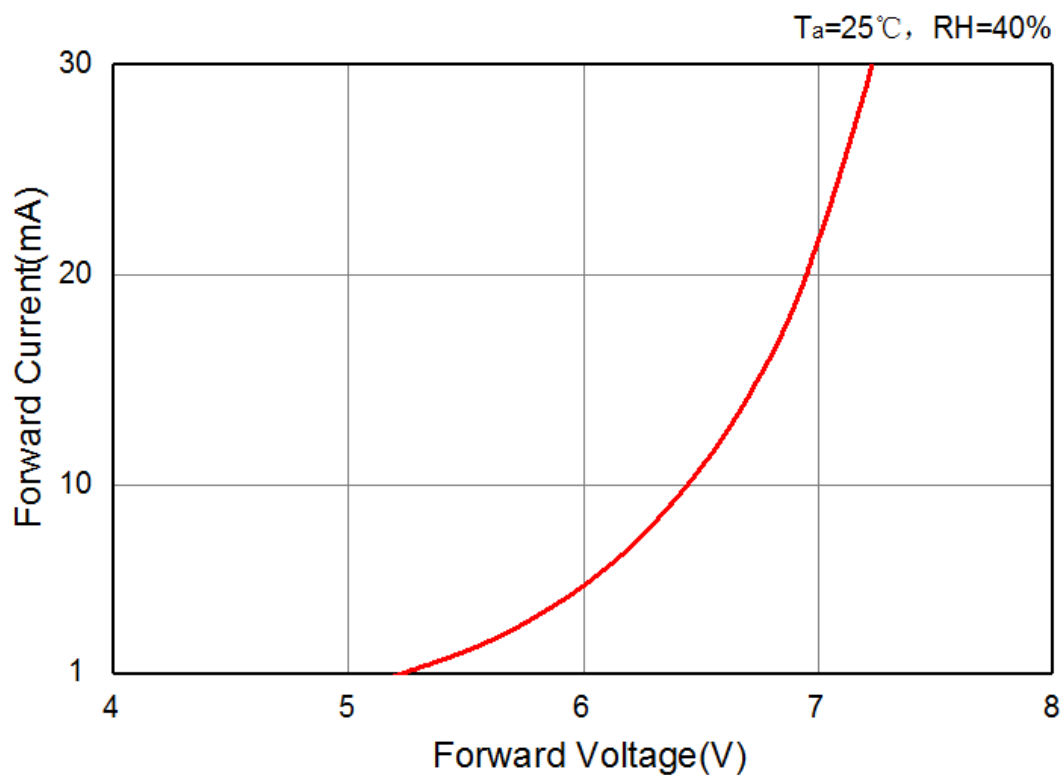
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Characteristics Diagrams

1.Relative Spectrum Power Distribution



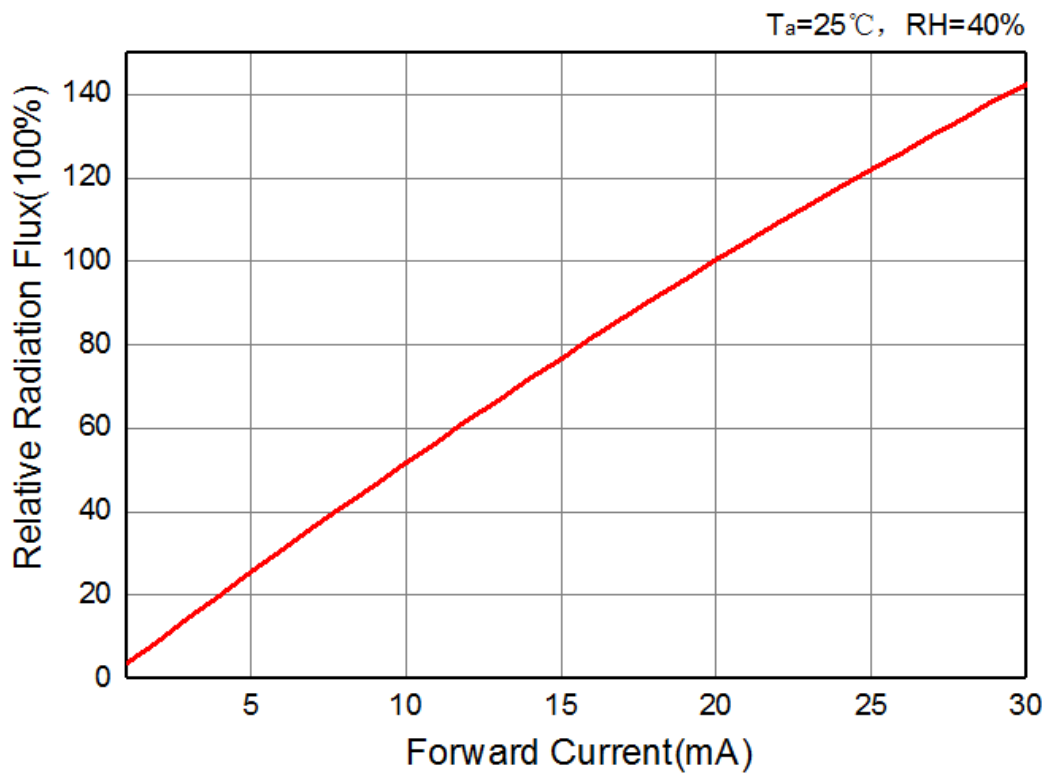
2.Forward Voltage vs Forward Current



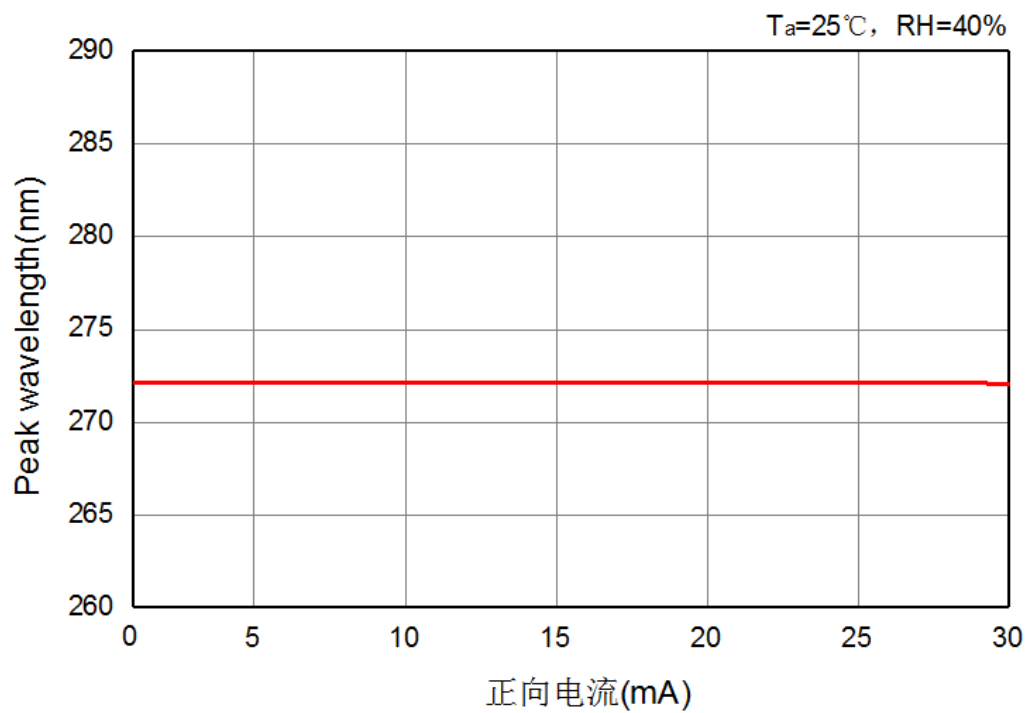


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3.Relative Radiation Flux vs Forward Current



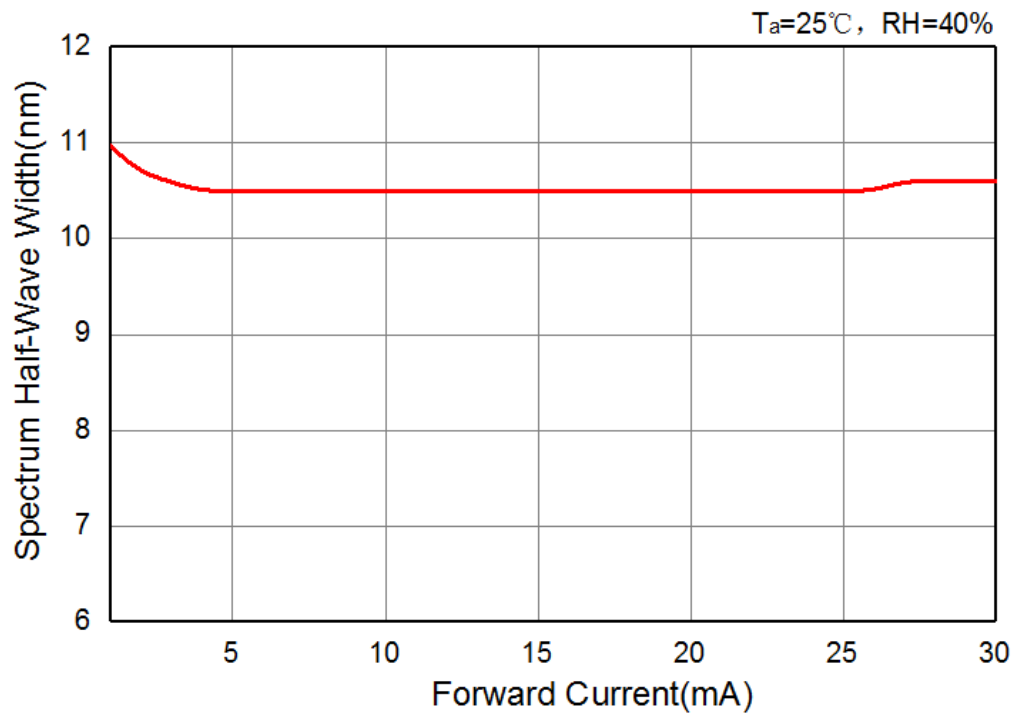
4.Peak Wavelength vs Forward Current



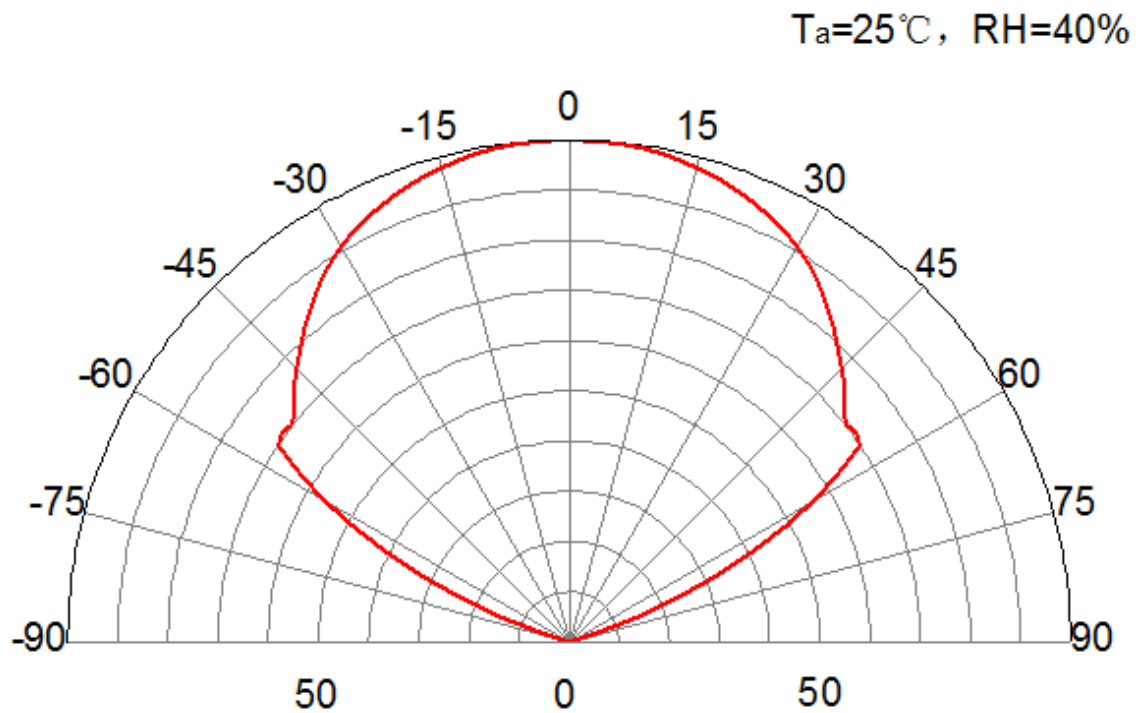


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5.Spectrum Half-Wave Width vs Forward Current



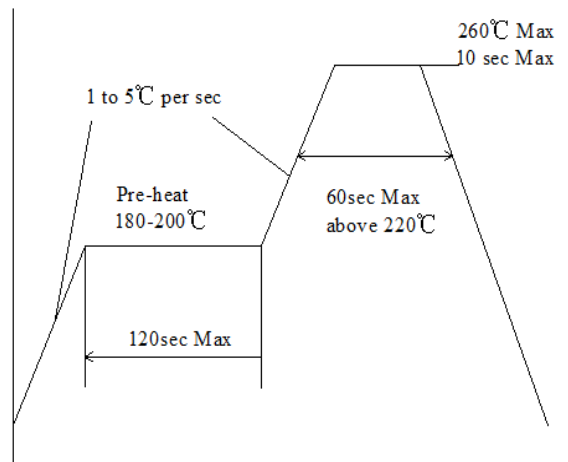
6.Spatial Distribution Graph



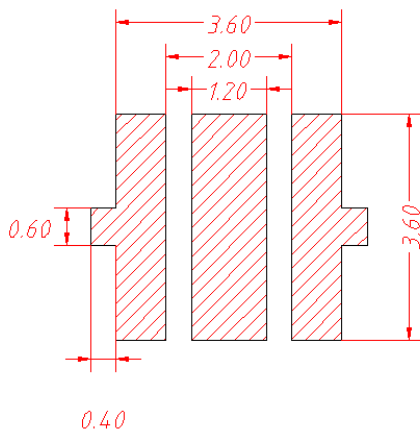


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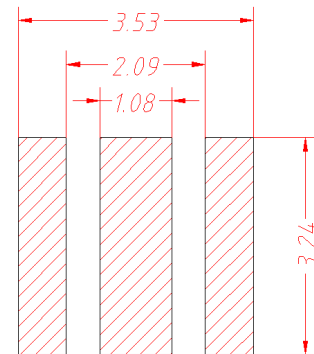
Product Application Information



Recommended Reflow Soldering Condition (Lead-free solder)



Recommended Soldering pad Layout
(Unit: mm)



Recommended Soldering Mask Layout
(Unit: mm)

Notes:

- *This LED is designed to be reflow soldered on to a PCB. If dip soldered or hand soldered, Bytech cannot guarantee its reliability.
- *Reflow soldering must not be performed more than twice.
- *Avoid rapid cooling. Ramp down the temperature gradually from the peak temperature.
- *Nitrogen reflow soldering is recommended. Air flow soldering conditions can cause optical degradation, caused by heat and/or atmosphere.
- *Since the glass used in the encapsulating glass is fragile, do not press on the hermetic glass. pressure can cause nicks, chip-outs, Sealant layer and deformation, and wire breaks, decreasing reliability
- *Repairing should not be done after the LEDs have been soldered.
It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- *The Die Heat Sink should be soldered to customer PCB. If it is difficult or impossible, use high heat-dissipating adhesive.
- *When soldering, do not apply stress to the LED while the LED is hot.
- *When using a pick and place machine, choose an appropriate nozzle for this product.
- *When flux is used, it should be a halogen free flux. Ensure that the manufacturing process is not designed in a manner Where the flux will come in contact with the LEDs.
- *Make sure that there are no issues with the type and amount of solder that is being used.



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CAUTIONS

1. Handling Precautions

- Do not handle the LEDs with bare hands as it will contaminate the LEDs surface and may affect the optical characteristics.
- When handling the product with tweezers, be careful not to apply excessive force to the glass. Otherwise, the glass can be cut, chipped, delaminate or deformed, causing wire-bond breaks and catastrophic failures.
- Dropping the product may cause damage.

2. Electrostatic Discharge (ESD)

- The product are sensitive to static electricity or surge voltage. ESD can damage a die and its reliability. When handling the products, the following measure against electrostatic discharge are strongly recommended:

Eliminating wrist strap, ESD footwear, clothes, and floors

Grounded workstation equipment and tools

ESD table/shelf mat made of conductive materials

- Ensure that tools, jigs and machines that are being used are properly grounded and that proper grounding techniques are used in work areas. For devices/equipment that mount the LEDs, protection against surge voltages should also be used.

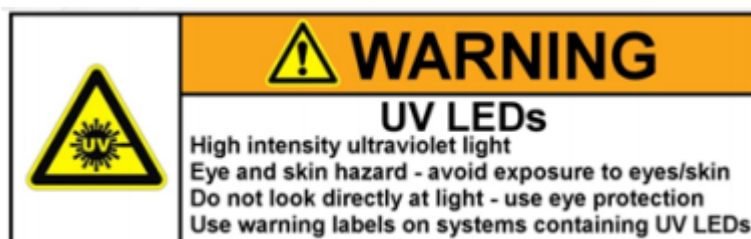
- The customer is advised to check if the LEDs are damage by ESD

When performing the characteristics inspection of the LEDs in the application.

Damage can be detected with a forward voltage measurement at low current($\leq 1\text{mA}$).

3. Eye Safety

- Please proceed with caution when handling any UVLEDs driven at low or high current. Since UV light can be harmful to eyes, do Not look directly into the UV light, even through an optical instrument.
- UV protective glasses are required to use in order to avoid damage by UV light in case of viewing UV light directly.





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History of Revision

Revision	Date	Contents of Revision Change	Remark
REV NO: 1.0	2018.08.14	New Establishment	
REV NO:2.0	2018.08.15	Change the image with dimensions	The dimensions can not see clearly